



Call for Papers for Software Engineering Symposiums (SEPA & ISSQ in LNCS by Springer, TTSDP in IEEE Xplore)@ICCSA 2019, July 01-04, 2019, Saint Petersburg University, Russia

SUBMISSION DATE: 31.03.2019, Submission Site: <http://ess.iccsa.org/cqi-bin/login.py>

Request: May I kindly request you to submit your paper(s) and circulate the following CFP in your department, Software/Computer engineering groups and all interested researchers who may be potential authors. All the publications will be in LNCS(Springer) as a book series of Computational Science and Its Applications: **ICCSA** and IEEE Xplore. Please visit the following site for more detail.

Any author who need sufficient time for applying funding, we will provide reviews within 30 days. Please inform us after submission.

11th International Symposium on Software Engineering Processes and Applications (SEPA)-2019 (Publication in LNCS by Springer):

<http://www.wikicfp.com/cfp/servlet/event.showcfp?eventid=84204©ownerid=3644>

<http://sepa.covenantuniversity.edu.ng/>

10th International Symposium Software Quality- (ISSQ)-2019-Publish in LNCS by Springer

<http://www.wikicfp.com/cfp/servlet/event.showcfp?eventid=84205©ownerid=3644>

<http://sq.covenantuniversity.edu.ng/>

11th Int Workshop on Tools and techniques in Software Development Processes (TTSDP)-2019(Publication in IEEE Xplore):

<http://www.wikicfp.com/cfp/servlet/event.showcfp?eventid=84206©ownerid=3644>

<http://ttsdp.covenantuniversity.edu.ng/>

If your paper is a theme paper and 10-16 pages long (LNCS Format), belongs/related to general and applications area of software engineering (e.g.-application or use of software/model/algorithms/tools/frameworks in clouds, IOT, healthcare, security etc. and Software Intelligent systems), please submit it in Software Engineering process and applications (SEPA 2019). If you are working in any area related to quality issues of Software/Software engineering, consider Software Quality (ISSQ 2019) for your submission. Further, if your paper is a session paper which is short and up to 4-6 pages (in IEEE format), please select TTSDP 2019 for your submission.

The extended version (minimum 30% in technical content) of SEPA 2019, SQ 2019 and TTSDP 2019 papers will be accepted by Several Journals (all in SCOPUS/ESCI & **best papers in SCIE Indexed Journal-confirmed**).

The website for submission is open on following link- <http://ess.iccsa.org/>

While submitting your paper don't forget to select the proper session/workshop.

Hope and request for your contribution.

Prof Sanjay Misra, Organizing Chair: SEPA 2019, ISSQ-2019, TTSDP-2019

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